KOBAYASHI, S. Appl. No. 10/632,850 November 21, 2005

AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

- 1. (Currently amended) A <u>multiple exposure</u> mask pattern for multiple exposures for forming a resist pattern with an unvarying pattern pitch on a semiconductor wafer, which is utilized <u>instead of as in case where</u> a <u>one exposure mask pattern under a design</u> having [[the]] a width of an aperture pattern <u>of the one exposure mask</u> smaller than [[the]] a width of a light-shielding pattern is used at one exposure of the one exposure mask, wherein the <u>multiple exposure</u> mask pattern for multiple exposures comprises an aperture pattern and a light-shielding pattern with apertures between light-shielding portions, where the multiple exposure mask <u>pattern</u> has a pattern pitch that is the same as that of the <u>one exposure</u> mask pattern <u>under design</u> and has a the width of [[an]] the aperture pattern <u>of the multiple exposure mask pattern that is greater than [[the]] a width of [[a]] the light-shielding pattern <u>of the multiple exposure mask pattern that is greater than [[the]] a width of [[a]] the light-shielding pattern <u>of the multiple exposure mask pattern</u>.</u></u>
- 2. (Currently amended) The mask pattern according to claim 1, wherein the <u>multiple</u> exposure mask pattern is formed of chrome.
- 3. (Currently amended) The mask pattern according to claim 1, wherein the <u>multiple</u> exposure mask pattern is formed of silicon.

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4. (Currently amended) The mask pattern according to claim 1, wherein the aperture pattern of the multiple exposure mask pattern is formed using a halftone mask that becomes a phase shifter.

5. (Currently amended) The mask pattern according to claim 1, wherein the aperture pattern of the multiple exposure mask pattern is formed using a Levenson mask that becomes a phase shifter.

6. (Currently amended) The mask pattern according to claim 1, wherein the light-shielding pattern of the multiple exposure mask pattern is formed by using a binary mask made of chrome.

7. (Currently amended) The mask pattern according to claim 1, wherein the light-shielding pattern of the multiple exposure mask pattern is formed by using a halftone mask made of MoSiO.

8. (Canceled)